# ZETTLER DISPLAYS

## SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY

	CUSTOMER APP	ROVAL	
<b>※ PART</b>	'NO.: <u>ATM0350B47B</u> (2	ZETTLER DISP	LAYS) V1.1
APPROVAL		COMPANY CHOP	
CUSTOMER COMMENTS			
COMMENTS			

ZETTLER DISPLAYS ENGINEERING APPROVAL					
DESIGNED BY	CHECKED BY	APPROVED BY			
ZZK					

## **REVISION RECORD**

REVISION	REVISION DATE	PAGE	CONTENTS
VER1.0	2021-08-25		FIRST ISSUE
VER1.1	2024-12-31	19	UPDATE PRECAUTION

#### **\*** CONTENTS

- 1. GENERAL SPECIFICATIONS
- 2. PIN ASSIGNMENT
- 3. OPERATING SPECIFICATIONS
- 4. OPTICAL SPECIFICATIONS
- 5. RELIABILITY TEST
- 6. PRECAUTION FOR USING LCM
- 7. MECHANICAL DRAWING
- 8. PACKAGE DRAWING
- 9. INSPECTION SPECIFICATION

## 1. GENERAL SPECIFICATIONS

Item	Specification	Remark
1. LCD size	3.5 inch(Diagonal)	
2. Driver element	a-Si TFT active matrix	
3. Resolution	320x(RGB)x240	
4. Display mode	Normally white, TN,Transmissive	
5. Dot Pitch (W*H)	0.073mm(W) x 0.219mm(H)	
6. Pixel pitch(W*H)	0.219mm(W) x 0.219mm(H)	
7. Active Area(W*H)	70.08mm(W) x 52.56mm(H)	
8. Module size (W*H)	76.9mm(W) x 63.9mm(H) x 3.3mm(D)	Note 1
9. Surface treatment	Anti-glare	
10. Color arrangement	RGB-stripe	
11. Color	262K	
12. Viewing angle (L/R/T/B)	60/60/60/30	
13. Interface	MCU/RGB	
14. LCD controller	SSD2119AM1	
15. LCM brightness	400 cd/m2 Typ.	
16. Backlight driving condition	20mA @18.6V	
17. Touch panel	N.A.	
18. Touch controller	N.A.	
19. Operation temperature	-20~70 °C	
20. Weight	32g	
21. RoHS	RoHS compliant	

Note 1: Please refer to mechanical drawing.

## 2. PIN ASSIGNMENT

**TFT LCD Panel Driving Section**FPC Connector is used for the module electronics interface. The recommended model is FH12A-50S-0.5SH manufactured by Hirose.

Pin No.	Symbol	Function	Level	Note
1	VCI	Booster input voltage pin	Р	
2	VCI	Booster input voltage pin	Р	
3	VSS	Ground (0V)	Р	
4	VDDIO	Voltage input pin for logic	Р	
5	VSS	Ground (0V)	Р	
6	RESET	Reset Signal pin ("Low" is enable)	I	
7	DC/SDC(RS)	Data or Command select PIN.	I	
		6800 system: E(enable signal)		
8	E/RD	8080 system: RD(read strobe signal)	1	
	2,11,3	Serial mode: Not use and should be connected to $V_{\text{DDIO}}$ or $V_{\text{SS}}$	·	
		6800 system: RW (indicates read cycle when high,		
9	WR	write cycle when low)	I	
40	00	8080 system: WR (write strobe signal)	<del> </del>	
10	CS	Chip select	l l	
11	SCL	Serial Clock.	l	
12	SD0	Data output pin in serial interface	0	
13	SDI	Data input pin in serial interface	I	
14	WSYNC(NC)	Ram write synchronization output. Leave it OPEN when not used.	0	
		Data bus		
45.00		For parallel mode, 8/9/16/18 bit interface.		
15~32	D17~D0	Please refer to Section 15 Interface Mapping Section for definition.	I/O	
		Unused pins should connect to V <sub>SS</sub> .		
33	VSS	Ground	Р	
34	DOTCLK	Dot-clock signal and oscillator source	I	
35	HSYNC	Line Synchronization input		
36	VSYNC	Frame/Ram Write Synchronization input	I	
37	DE	Display enable pin for controller	I	
38	VSS	Ground	Р	
39	PS0		1	
40	PS1	Interface coloct DIM	I	
41	PS2	Interface select PIN		
42	PS3			
43	VSS	Ground	Р	
44	NC (XR)	NC		
45	NC (YD)	NC		
46	NC (XL)	NC		

47	NC (YU)	NC		
48	VSS	Ground	Р	
49	LEDK	Backlight LED Cathode	I	
50	LEDA	Backlight LED Anode.	I	

I: input, O: output, P: Power

PS3	PS2	PS1	PS0	Interface Mode
0	0	0	0	16-bit 6800 parallel interface
0	0	0	1	8-bit 6800 parallel interface
0	0	1	0	16-bit 8080 parallel interface
0	0	1	1	8-bit 8080 parallel interface
0	1	0	0	9-bit generic D[17:9] (262k colour) + 3-wire SPI If 65K color, D12 shorts to D17 internally
0	1	0	1	16-bit generic (262k colour) + 3-wire SPI
0	1	1	0	18-bit generic (262k colour) + 3-wire SPI
0	1	1	1	6-bit generic D[17:12] (262k colour) + 3-wire SPI
1	0	0	0	18-bits 6800 parallel interface
1	0	0	1	9-bits 6800 parallel interface
1	0	1	0	18-bit 8080 parallel interface
1	0	1	1	9-bit 8080 parallel interface
1	1	1	0	3-wire SPI
1	1	1	1	4-wire SPI

## 3. Operating Specification

#### 3.1 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Val	ues	Unit	Remark	
item	Symbol	Min.	Max.	Oilit	Kemark	
Power Voltage	$V_{DD}$	-0.3	5.0	V		
Operation Temperature	T <sub>OP</sub>	-20	70	°C		
Storage Temperature	T <sub>ST</sub>	-30	80	°C		
LED Reverse Voltage	V <sub>R</sub>	-	1.2	V	Each LED Note 2	
LED Forward Current	l <sub>F</sub>		25	mA	Each LED	

**Note 1**: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 2: V<sub>R</sub> Conditions: Zener Diode 20mA

#### 3.2 Typical Operation Conditions

Item	Symbol		Values	Unit	Remark	
item	Syllibol	Min.	Тур.	Max.	Onit	Kelliaik
Power Voltage	$V_{DD}$	2.5	3.3	3.6	V	Note 1
Input Logic High Voltage	V <sub>IH</sub>	0.8VCC		VCC	V	
Input Logic Low Voltage	$V_{IL}$	0		0.2VCC	V	

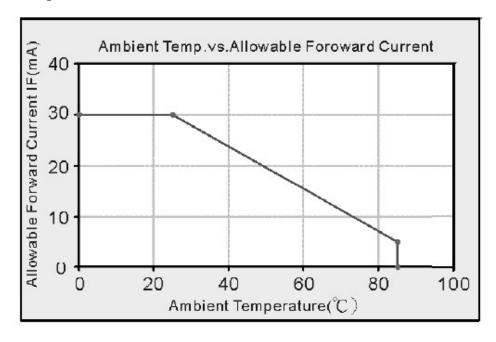
**Note 1**: V<sub>DD</sub> setting should match the signals output voltage of customer's system board.

## 3.3 Backlight driving conditions

Item	Symbol		Values	Unit	Remark	
item	Symbol	Min.	Тур.	Max.	Oilit	Kemark
Voltage for LED Backlight	$V_L$	17.4	18.6	21.0	V	Note 1
Current for LED Backlight	IL		20		mA	
LED life time			50000		Н	Note 2

**Note 1**: The LED Supply Voltage is defined by the number of LED at Ta=25 $^{\circ}$ C and I<sub>L</sub> =20mA.

**Note 2**: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25  $^{\circ}$ C and I<sub>L</sub> =20mA.



## 3.4 Timing Characteristics

**Table 3-1: Parallel 6800 Timing Characteristics** 

 $(T_A = -40 \text{ to } 85^{\circ} \text{ C}, V_{DDIO} = 1.4 \text{V to } 2.4)$ 

Symbol	Parameter	Min	Тур	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time (write cycle)	75	-	-	ns
t <sub>cycle</sub>	Clock Cycle Time (read cycle) (Based on VOL/VOH = 0.3*VDDIO/0.7*VDDIO)	1000	-	-	ns
t <sub>AS</sub>	Address Setup Time (R/W)	0	-	-	ns
t <sub>AH</sub>	Address Hold Time (R/W)	0	-	-	ns
t <sub>DSW</sub>	Data Setup Time (D0~D7, WRITE)	5	-	-	ns
t <sub>DHW</sub>	Data Hold Time (D0~D7, WRITE))	5	-	-	ns
t <sub>ACC</sub>	Data Access Time (D0~D7, READ)	250	-	-	ns
t <sub>OH</sub>	Output Hold time (D0~D7, READ)	100	-	-	ns
PWcsl	Pulse width /CS low (write cycle)	40	-	-	ns
PW <sub>CSH</sub>	Pulse width /CS high (write cycle)	25	-	-	ns
PW <sub>CSL</sub>	Pulse width /CS low (read cycle)	500	-	-	ns
PWcsh	Pulse width /CS high (read cycle)	500	-	-	ns
t <sub>R</sub>	Rise time	-	-	15	ns
t <sub>F</sub>	Fall time	-	-	15	ns

(T<sub>A</sub> = -40 to 85 $^{\circ}$  C, V<sub>DDIO</sub> = 2.4V to 3.6V)

Symbol	Parameter	Min	Тур	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time (write cycle)	75	-	-	ns
t <sub>cycle</sub>	Clock Cycle Time (read cycle) (Based on VOL/VOH = 0.3*VDDIO/0.7*VDDIO)	450	-	-	ns
tas	Address Setup Time (R/W)	0	-	-	ns
t <sub>AH</sub>	Address Hold Time $(R/\overline{W})$	0	-	-	ns
t <sub>DSW</sub>	Data Setup Time (D0~D7, WRITE)	5	-	-	ns
t <sub>DHW</sub>	Data Hold Time (D0~D7, WRITE))	5	-	-	ns
t <sub>ACC</sub>	Data Access Time (D0~D7, READ)	200	-	-	ns
tон	Output Hold time (D0~D7, READ)	100	-	-	ns
PWcsl	Pulse width /CS low (write cycle)	40	-	-	ns
PW <sub>CSH</sub>	Pulse width /CS high (write cycle)	25	-	-	ns
PWcsL	Pulse width /CS low (read cycle)	225	-	-	ns
PW <sub>CSH</sub>	Pulse width /CS high (read cycle)	225	-	-	ns
t <sub>R</sub>	Rise time	-	-	15	ns
t <sub>F</sub>	Fall time	-	l -	15	ns

Note: CS can be pulled low during the write cycle, only /WR is needed to be toggled.

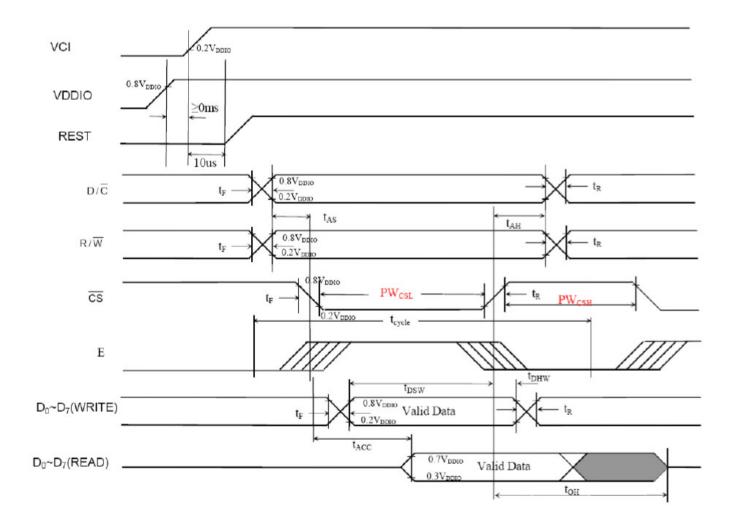


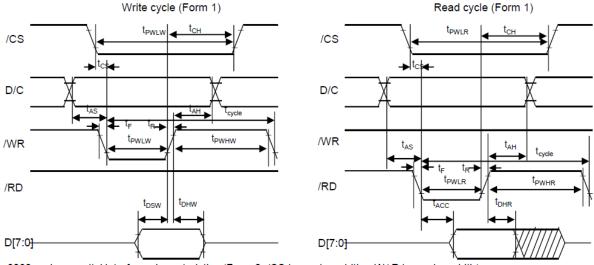
Figure 3-1: Parallel 6800-series Interface Timing Characteristics

**Table 3-2: Parallel 8080 Timing Characteristics** 

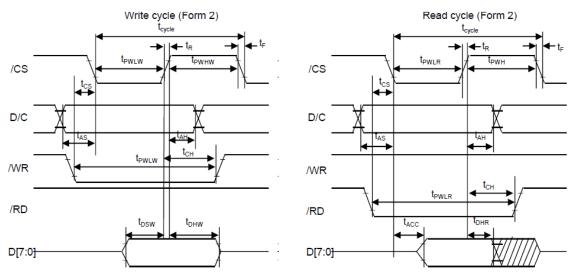
Symbol	Parameter	Min	Тур	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time (write cycle)	100	-	-	ns
t <sub>AS</sub>	Address Setup Time	10	-	-	ns
t <sub>AH</sub>	Address Hold Time	0	-	-	ns
tcs	Chip Select Time	0	-	-	ns
t <sub>CH</sub>	Chip Select Hold Time	0	-	-	ns
t <sub>DSW</sub>	Write Data Setup Time	10	-	-	ns
t <sub>DHW</sub>	Write Data Hold Time	10	-	-	ns
t <sub>DHR</sub>	Read Data Hold Time	100	-	-	ns
t <sub>ACC</sub>	Access Time (RAM)	250	-	-	ns
	Access Time (command)		-	-	ns
t <sub>PWLR</sub>	Chip Select Low Pulse Width (read RAM)	500	-	-	ns
tpwlr	Chip Select Low Pulse Width (read Command)	500	-	-	ns
t <sub>PWLW</sub>	Chip Select Low Pulse Width (write)	50	-	-	ns
t <sub>PWHR</sub>	Chip Select High Pulse Width (read)	500	-	-	ns
t <sub>PWHW</sub>	Chip Select High Pulse Width (write)	50	-	-	ns
t <sub>R</sub>	Rise Time	-	-	15	ns
t <sub>F</sub>	Fall Time	-	-	15	ns

Note: All timings are based on 20% to 80% of  $V_{\text{DDIO}}\text{-}V_{\text{SS}}$ 

#### 8080-series parallel interface characteristics (Form 1: /CS low pulse width > W/ R low pulse width)



8080-series parallel interface characteristics (Form 2: /CS low pulse width < W/ R low pulse width)

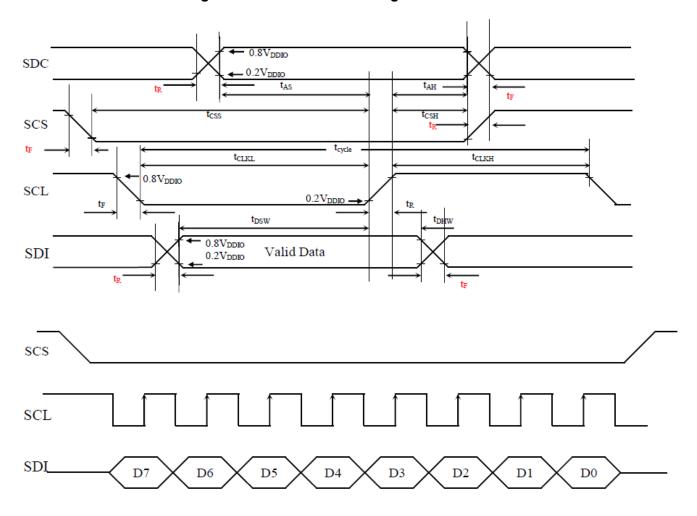


**Table 3-3: Serial Timing Characteristics** 

 $(T_A = -40 \text{ to } 85^{\circ} \text{ C}, V_{DDIO} = 1.4 \text{V to } 3.6 \text{V})$ 

Symbol	Parameter	Min	Тур	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	77	-	-	ns
f <sub>CLK</sub>	Serial Clock Cycle Time SPI Clock tolerance = +/- 2 ppm	-	-	15	MHz
t <sub>AS</sub>	Register select Setup Time	4	-	-	ns
t <sub>AH</sub>	Register select Hold Time	5	-	-	ns
t <sub>CSS</sub>	Chip Select Setup Time	2	-	-	ns
t <sub>CSH</sub>	Chip Select Hold Time	10	-	-	ns
t <sub>DSW</sub>	Write Data Setup Time	5	-	-	ns
t <sub>OHW</sub>	Write Data Hold Time	10	-	-	ns
t <sub>CLKL</sub>	Clock Low Time	38	-	-	ns
t <sub>CLKH</sub>	Clock High Time	38	-	-	ns
t <sub>R</sub>	Rise time	-	-	15	ns
t <sub>F</sub>	Fall time	-	-	15	ns

Figure 3-2: 4 wire Serial Timing Characteristics



**Table 3-4: RGB Timing Characteristics** 

( $T_A$  = -40 to 85° C,  $V_{DDIO}$  = 1.4V to 3.6V )

Symbol	Parameter	Min	Тур	Max	Unit
f <sub>DOTCLK</sub>	DOTCLK Frequency (70Hz frame rate)	1	5.5	8.2	MHz
t <sub>DOTCLK</sub>	DOTCLK Period	122	182	1000	ns
t <sub>VSYS</sub>	Vertical Sync Setup Time	20	-	-	ns
t <sub>VSYH</sub>	Vertical Sync Hold Time	20	-	-	ns
t <sub>HSYS</sub>	Horizontal Sync Setup Time	20	-	-	ns
t <sub>HSYH</sub>	Horizontal Sync Hold Time	20	-	-	ns
t <sub>HV</sub>	Phase difference of Sync Signal Falling Edge	0	-	HFP-1	tDOTCLK
t <sub>CLK</sub>	DOTCLK Low Period	61	-	-	ns
t <sub>CKH</sub>	DOTCLK High Period	61	-	-	ns
t <sub>DS</sub>	Data Setup Time	25	-	-	ns
t <sub>DH</sub>	Data hold Time	25	-	_	ns

Note: External clock source must be provided to DOTCLK pin of SSD2119AM1. The driver will not operate in absence of the clocking signal.

\*HFP: Horizontal Front Porch setting in customers' setup

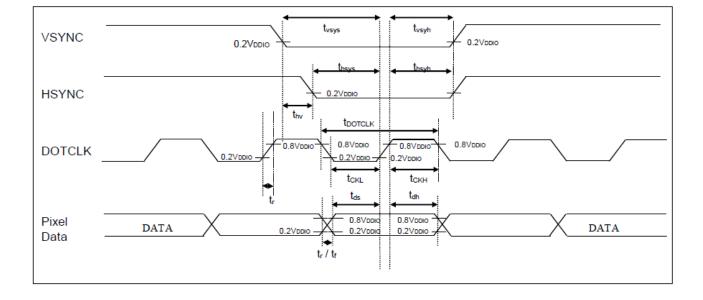


Figure 3-3: RGB Timing Characteristics

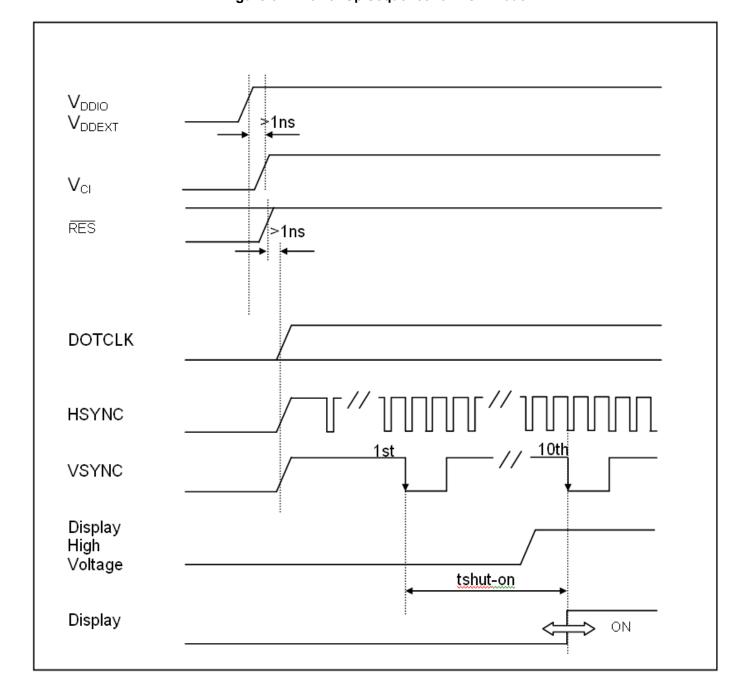


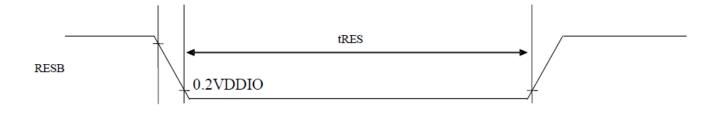
Figure 3-4: Power Up Sequence for RGB mode

**Table 3-5: Reset Timing** 

 $(T_A = -40 \text{ to } 85^{\circ} \text{ C}, V_{DDIO} = 1.4 \text{V to } 3.3 \text{V})$ 

Symbol	Parameter	Min	Тур	Max	Unit
t <sub>RES</sub>	Reset pulse duration	15			us

**Figure 3-5: Reset Timing Characteristics** 



## **4.0 OPTICAL SPECIFICATIONS**

ltem	Symbol	Condition		Values		Unit	Domork	
item	Syllibol	Condition	Min.	Тур. Мах.		Oill	Remark	
	$\theta_{L}$	Φ=180°(9 O'CLOCK)	50	60				
Viewing Angle	$\theta_{R}$	Φ=0°(3 O'CLOCK)	50	60		degree	Note 1	
(CR≥10)	$\theta_{T}$	Φ=90°(12 O'CLOCK)	50	60				
	$\theta_{B}$	Φ=270°(6 O'CLOCK)	20	30				
Response Time	T <sub>ON +</sub> T <sub>OFF</sub>	DFF		30	50	msec	Note 3	
Contrast Ratio	CR		150	300			Note 4	
	$W_X$	Normal	0.26	0.31	0.36		Note 2	
Color Chromaticity	W <sub>Y</sub>	Θ=Φ=0°	0.26	0.31	0.36		Note 5 Note 6	
Luminance	L		350	400		cd/m <sup>2</sup>	Note 6	
Luminance Uniformity	YU		70	80		%	Note 7	

#### **Test Conditions:**

- 1. VCC=3.3V, IL=20mA (Backlight current), the ambient temperature is 25  $^{\circ}$ C.
- 2. The test systems refer to Note 2.

#### Note 1: Definition of viewing angle range

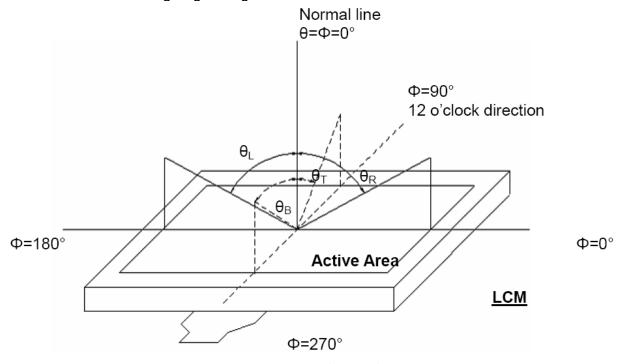


Figure 4.1 Definition of viewing angle.

#### Note 2: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON

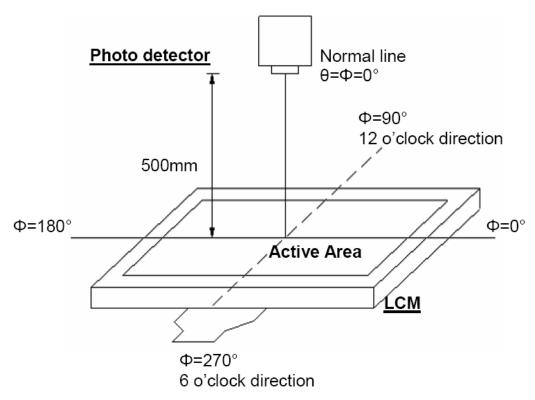


Figure 4.2 Optical measurement system setup

#### Note 3: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.

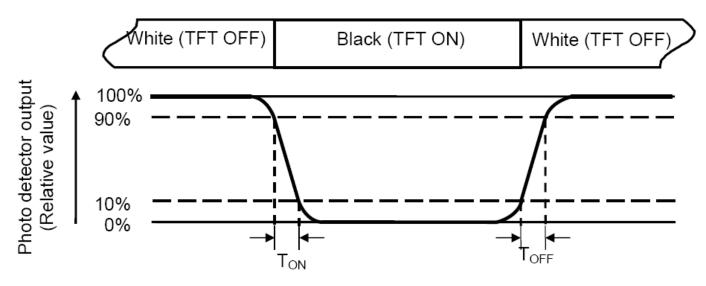


Figure 4.3 Definition of response.

#### Note 4: Definition of contrast ratio

Contrast ratio(CR)= Luminance measured when LCD on the "white" state Luminance measured when LCD on the "black" state

#### Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

**Note 6**: All input terminals LCD panel must be ground while measuring the center area of the panel. The LED driving condition is  $I_L$ =20mA .

#### Note 7: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer to Fig. 4-4 ). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (Yu) = 
$$\frac{B_{min}}{B_{max}}$$

L-----Active area length W----- Active area width

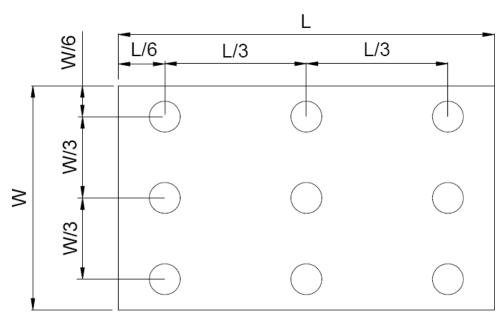


Figure 4.3 Definition of measuring points.

Bmax: The measured maximum luminance of all measurement position. Bmin: The measured minimum luminance of all measurement position.

#### **5. RELIABILITY TEST**

Item	Test Condition Item	Remark
High temperature storage	Ta= 80 °C 120hrs	Note 1 Note 4
Low temperature storage	Ta=-30 °C 120hrs	Note 1 Note 4
High temperature operation	Ts= 70 °C 96hrs	Note 2 Note 4
Low temperature operation	Ts=-20 °C 96hrs	Note 1 Note 4
High temperature/High humidity operation	90% RH 60°C 120hrs	Note 4
Thermal Shock (Non-operation)	-20 $^{\circ}$ C/30 min $^{\circ}$ +60 $^{\circ}$ C/30 min for a total 30 cycles, Start with cold temperature and end with high temperature.	Note 4
Vibration test	Freq:10~55~10Hz Amplitude:1.5mm 2 hours for each direction of X,Y,Z (6 hours for total)	
Mechanical shock	60G 6ms,±X, ±Y, ±Z 3 times for each direction	
Package vibration test	Random Vibration: 0.015G*G/Hz from 5-200HZ, -6dB/Octave from 200-500HZ 2 hours for each direction of X. Y. Z. (6 hours for total)	
Package drop test	Height:60 cm 1 corner, 3 edges, 6 surfaces	
Electro static discharge	± 2KV, Human Body Mode, 150pF/330Ω	

**Note 1**: Ta is the ambient temperature of samples.

**Note 2**: Ts is the temperature of panel's surface.

**Note 3**: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

**Note 4**: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

#### 6. PRECAUTION FOR USING LCM

- When design the product with this LCD Module, make sure the viewing angle matches to its purpose of usage.
- 2. As LCD panel is made of glass substrate, dropping the LCD module or banging it against hard objects may cause cracking or fragmentation. Especially at corners and edges.
- Although the polarizer of this LCD Module has the anti-glare coating, always be careful not to scratch its surface.Use of a plastic cover is recommended to protect the surface of polarizer.
- 4. If the LCD module is stored below specified temperature, the LC material may freeze and be deteriorated. If it is stored above specified temperature, the molecular orientation of the LC material may change to Liquid state and it may not revert to its original state. And also excessive temperature and humidity could cause polarizer peel off or bubble. Therefore, the LCD module should always be stored within specified temperature and humidity range. If the LCD modules will be stored for a long time, the recommend temperature/humidity for the storage environment is:

Temperature : 15°C ~ 35°C / Relatively humidity: ≤80%

- 5. Meanwhile please follow other requirements below for storage:
  - -Store with no touch on display surface by the anything else. If possible, store the LCD in the packaging situation when it was delivered.
- -If the original package is opened, please store in an anti-static polyethylene bag and seal it so as not to get fresh air outside enter into it.
  - LCD modules shall be stored in a dark place. And it shall not be exposed to sunlight nor fluorescent light in storage.

Note: If the storage time is over 1 year, the golden fingers of FPC might be slightly oxidized, but it won't affect the electrical performance, customer can use rubber to clean the golden fingers before assembly or directly assemble the display.

6. Saliva or water droplets must be wiped off immediately as those may leave stains or cause color changes if is remained there for a long time. And water vapor will cause corrosion of ITO electrodes.

If the surface of LCD panel needs to be cleaned, wipe it swiftly with cotton or other soft dry cloth. If it is not still clean enough, blow a breath on the surface and wipe again.

If needed, please just moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 7. The module should be driven according to the specified ratings to avoid malfunction and permanent damage. Applying DC voltage cause a rapid deterioration of LC material. Make sure to apply alternating waveform by continuous application of the M signal. Especially the power ON/OFF sequence should be kept to avoid latch-up of driver LSIs and DC charge up to LCD panel.
- 8. Mechanical Considerations
  - a) LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.
  - Do not tamper in any way with the tabs on the metal frame.
  - Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- 9. Static Electricity
  - a) Operator

Wear the electrostatics shielded clothes because human body may be statically charged if not ware shielded clothes. Never touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

b) Equipment

There is a possibility that the static electricity is charged to the equipment, which has a function of peeling or friction action (ex: conveyer, soldering iron, working table). Earth the equipment through proper resistance (electrostatic earth: 1x10<sup>8</sup> ohm).

Only properly grounded soldering irons should be used.

If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

c) Floor

Floor is the important part to drain static electricity, which is generated by operators or equipment.

There is a possibility that charged static electricity is not properly drained in case of insulating floor. Set the electrostatic earth (electrostatic earth: 1x10<sup>8</sup> ohm).

d) Humidity

Proper humidity helps in reducing the chance of generating electrostatic charges. Humidity should be kept over 50%RH.

e) Transportation/storage

The storage materials also need to be anti-static treated because there is a possibility that the human body or storage materials such as containers may be statically charged by friction or peeling.

The modules should be kept in antistatic bags or other containers resistant to static for storage.

f) Soldering

Soldering anything to this TFT display would void the warranty.

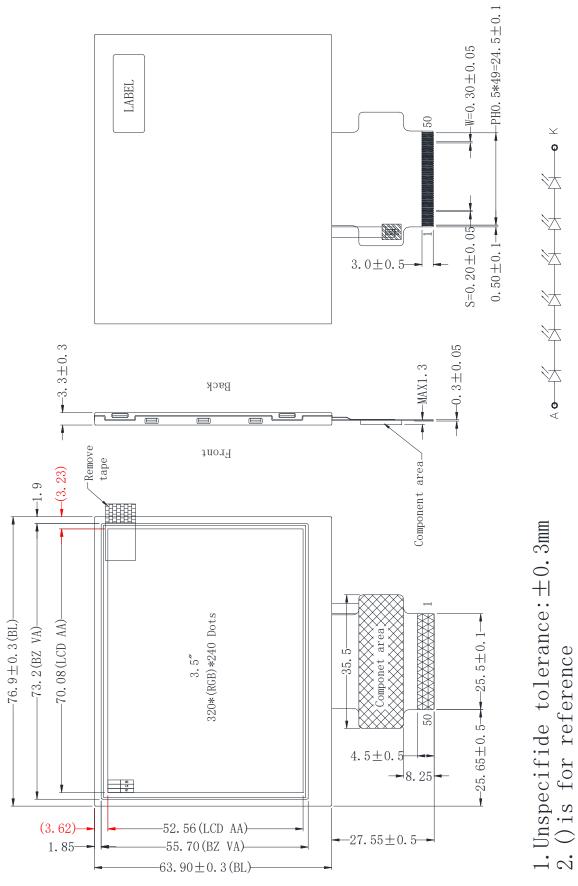
g) Others

The laminator (protective film) is attached on the surface of LCD panel to prevent it from scratches or stains. It should be peeled off slowly using static eliminator.

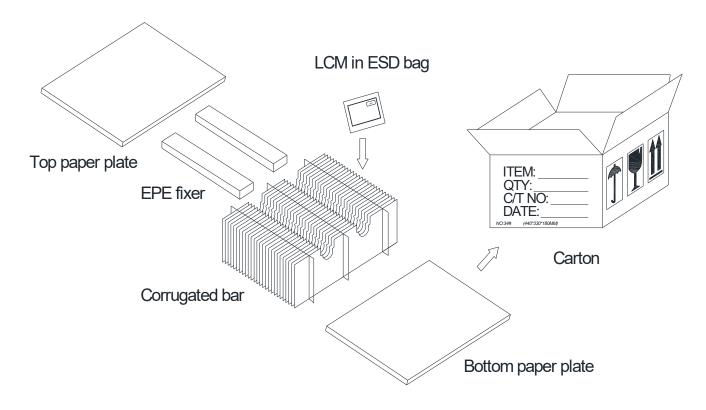
Static eliminator should also be installed to the workbench to prevent LCD module from static charge.

- 10. Operation
  - a) Driving voltage should be kept within specified range; excess voltage shortens display life.
  - b) Response time increases with decrease in temperature.
  - c) Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
  - d) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".
- 11. If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. The toxicity is extremely low but caution should be exercised at all the time.
- 12. Disassembling the LCD module can cause permanent damage and it should be strictly avoided.
- 13. LCD retains the display pattern when it is applied for long time (Image retention). To prevent image retention, do not apply the fixed pattern for a long time. Image retention is not a deterioration of LCD. It will be removed after display pattern is changed.
- 14. Do not use any materials, which emit gas from epoxy resin (hardener for amine) and silicone adhesive agent (dealcohol or deoxym) to prevent discoloration of polarizer due to gas.
- 15. Avoid the exposure of the module to the direct sunlight or strong ultraviolet light for a long time.

## 7. MECHANICAL DRAWING



## **8. PACKAGE DRAWING**



Carton size	53x36x26	cm
Quantity per carton	250	pcs

#### 9.0 INSPECTION SPECIFICATION

#### 1. SCOPE SPECIFICATIONS CONTAIN

1.1 DISPLAY QUALITY EVALUATION

1.2 MECHANICS SPECIFICATION

#### 2. SAMPLING PLAN

UNLESS THERE IS OTHER AGREEMENT, THE SAMPLING PLAN FOR INCOMING INSPECTION SHALL FOLLOW MIL-STD-105E.

- 2.1 LOT SIZE: QUANTITY PER SHIPMENT AS ONE LOT (DIFFERENT MODEL AS DIFFERENT LOT ).
- 2.2 SAMPLING TYPE: NORMAL INSPECTION, SINGLE SAMPLING.
- 2.3 SAMPLING LEVEL: LEVEL II.
- 2.4 AQL: ACCEPTABLE QUALITY LEVEL MAJOR DEFECT: AQL=0.65

MINOR DEFECT: AQL=1.0

#### 3. PANEL INSPECTION CONDITION

3.1 ENVIRONMENT:

ROOM TEMPERATURE: 25±5°C.

HUMIDITY: 65±5% RH.

ILLUMINATION: 300 ~ 700 LUX.

3.2 INSPECTION DISTANCE:

35±5 CM

3.3 INSPECTION ANGLE:

THE VISION OF INSPECTOR SHOULD BE PERPENDICULAR TO THE SURFACE OF THE MODULE.

3.4 INSPECTION TIME:

PERCEPTIBILITY TEST TIME: 20 SECONDS MAX.

#### 4. DISPLAY QUALITY

4.1 FUNCTION RELATED:

THE FUNCTION DEFECTS OF LINE DEFECT, ABNORMAL DISPLAY, AND NO DISPLAY ARE CONSIDERED MAJOR DEFECTS.

4.2 BRIGHT/DARK DOTS:

Defect Type	Specification	Major	Minor
Bright Dots	N≤ 2		•
Dark Dots	N≤ 3		•
Total Bright and Dark Dots	N≤ 4		•

Note: 1:

The definition of dot: The size of a defective dot over 1/2 of whole dot is regarded as one defective dot.

Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

The bright dot defect must be visible through 2% ND filter

Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.

#### 4.3 Pixel Definition:

R	G	В	R	G	В	R	G	В	Dot Defect
R	G	В	R	G	В	R	G	В	Adjacent Dot Defect
R	G	m	R	G	В	R	G	В	Cluster

#### Note 1:

If pixel or partial sub-pixel defects exceed 50% of the affected pixel or sub-pixel area, it shall be considered as1 defect.

#### Note 2:

There should be no distinct non-uniformity visible through 2% ND Filter within 2 sec inspection times.

#### 4.4Visual Inspection specifications:

Defect 1	Гуре	Specification Size	Count(N)	Major	Minor
Dot Shape		D ≤0.25 mm	Ignored		
1	cratch and Bubbles in	0.25mm < D ≤ 0.5mm	N ≤ 3		
display area					•
tuopia, ai oa	, - D	D > 0.5mm	N=0		
	-				
Novden Din	on (Only for Toyloh monol)	D≤70mm	N≤4		_
Newton Rin	ng (Only for Touch panel)	D>70mm	N=0		•
TSD Eich Ev	os (Only for Touch panel)	0.1mm <d≤0.2mm< td=""><td>N≤4</td><td></td><td></td></d≤0.2mm<>	N≤4		
1 SP FISH EY	es (Only for Touch panel)	0.2mm <d≤0.3mm< td=""><td>N≤3</td><td></td><td>•</td></d≤0.3mm<>	N≤3		•
(Bubble/Den	t)	0.3 <d≤0.4< td=""><td>N≤2</td><td></td><td></td></d≤0.4<>	N≤2		
Line Shape		W ≤ 0.01 mm	Ignored		
•	Scratch · Lint and Bubbles	0.01mm< W ≤ 0.05mm	N < 2		
in display are		and L ≤ 3mm	N ≤ 3		•
		W > 0.05mm or L > 3 mm	N=0		
	L ————————————————————————————————————				
Bubble in ce	ll (active area)	It should be found by eyes		•	
	Scratch				•
Bezel	Dirt	No harm			•
	Wrap	No harm		•	
	Sunken	No harm		•	
	No label				•
	Inverted label	No			•
	Broken				•
1 -11	Dirt	Word can be read.			•
Label	Not clear				•
	Word out of shape	No			•
	Mistake	No			•
	Position	Be attached on right position	n		•
	Not enough	No			•
Screw	Limp	No		•	
<u> </u>	P	1		1	I .

Connector	Connection status	No bend on pins and damage	•
FPC/FFC	Broken	No	•

Note: Extraneous substance and scratch not affecting the display of image, for instance, extraneous substance under polarizer film but outside the display area, or scratch on metal bezel and backlight module or polarizer film outside the display area, shall not be considered as defective or non-conforming.